



Product Change Notification / ALAN-11ELYX284

Date:

06-Jan-2022

Product Category:

32-bit Microcontrollers

PCN Type:

Manufacturing Change

Notification Subject:

CCB 4768 Final Notice: Qualification of ANAP as an additional assembly site for selected Atmel ATSAMG55J19A and ATSAMG55J19B device families available in 64L LQFP (10x10x1.4mm) package.

Affected CPNs:

[ALAN-11ELYX284_Affected_CPN_01062022.pdf](#)
[ALAN-11ELYX284_Affected_CPN_01062022.csv](#)

Notification Text:

PCN Status:Final Notification

PCN Type:Manufacturing Change

Microchip Parts Affected:Please open one of the files found in the Affected CPNs section.
Note: For your convenience Microchip includes identical files in two formats (.pdf and .xls)

Description of Change:Qualification of ANAP as an additional assembly site for selected Atmel ATSAMG55J19A and ATSAMG55J19B device families available in 64L LQFP (10x10x1.4mm) package.

Pre and Post Change Summary:

	Pre Change	Post Change
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CCB 4768
Pre and Post Change Summary
PCN# ALAN-11ELYX284



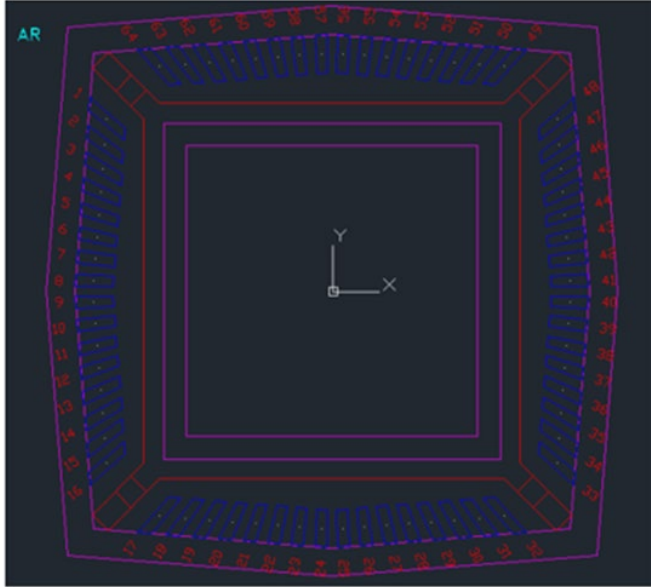
A Leading Provider of Smart, Connected and Secure Embedded Control Solutions



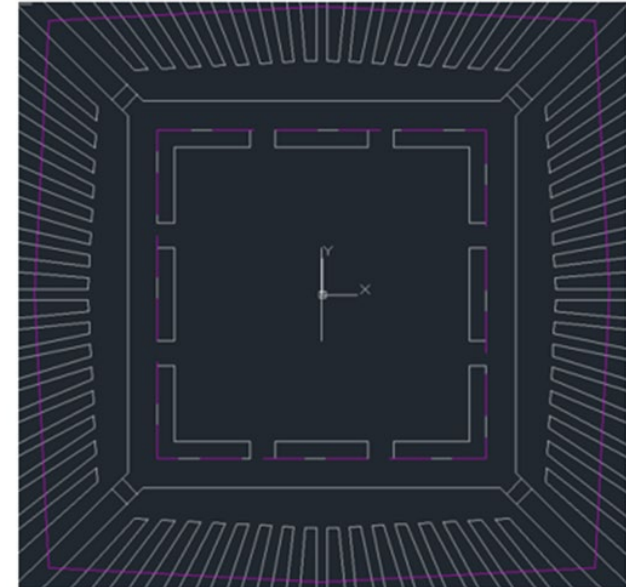
SMART | CONNECTED | SECURE

Pre and Post Change Summary

Pre Change



Post Change



Assembly location	ASE Inc. (ASE)
Lead frame material	C7025
Lead frame paddle size	200x200 mils

Assembly location	Amkor Technology Philippine (P1/P2), INC. (ANAP)
Lead frame material	C194
Lead frame paddle size	138x138 mils

Affected Catalog Part Numbers (CPN)

ATSAMG55J19A-AU

ATSAMG55J19B-AU

ATSAMG55J19A-AUT

ATSAMG55J19B-AUT